EcoSPARK[®] 2 Ignition IGBT

300 mJ, 500 V, N-Channel Ignition IGBT

Features

- SCIS Energy = 300 mJ at $T_J = 25^{\circ}C$
- Logic Level Gate Drive
- AEC-Q101 Qualified and PPAP Capable
- These Device is Pb-Free and are RoHS Compliant

Applications

- Automotive Ignition Coil Driver Circuits
- High Current Ignition System
- Coil on Plug Application

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
BV _{CER}	Collector to Emitter Breakdown Voltage (I _C = 1 mA)	500	V
BV _{ECS}	Emitter to Collector Voltage – Reverse Battery Condition ($I_C = 10 \text{ mA}$)	20	V
E _{SCIS25}	Self Clamping Inductive Switching Energy (Note 1)	300	mJ
E _{SCIS150}	Self Clamping Inductive Switching Energy (Note 2)	180	mJ
I _{C25}	Collector Current Continuous at V_{GE} = 4.0 V, T _C = 25°C	32	A
I _{C110}	Collector Current Continuous at V _{GE} = 4.0 V, T _C = 110°C	27	A
V _{GEM}	Gate to Emitter Voltage Continuous	±10	V
PD	Power Dissipation Total, $T_C = 25^{\circ}C$	150	W
	Power Dissipation Derating, for T_C > 25 $^\circ C$	1.1	W/°C
TJ	Operating Junction Temperature Range	-40 to +175	°C
T _{STG}	Storage Junction Temperature Range	-40 to +175	°C
ΤL	Max. Lead Temperature for Soldering (Leads at 1.6 mm from case for 10 s)	300	°C
Т _{РКG}	Max. Lead Temperature for Soldering (Package Body for 10 s)	j 260	
ESD	Electrostatic Discharge Voltage at 100 pF, 1500 Ω	4	kV

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

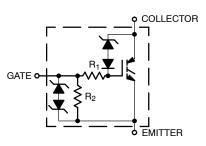
1. Self clamped inductive Switching Energy (ESCIS25) of 335 mJ is based on the test conditions that is starting $T_J = 25^{\circ}$ C, L = 3 mHy, ISCIS = 14.2 A, R_{GE} = 1 k Ω , VCC = 100 V during inductor charging and VCC = 0 V during time in clamp.

2. Self Clamped inductive Switching Energy (ESCIS150) of 180 mJ is based on the test conditions that is starting $T_J = 150^{\circ}$ C, L = 3mHy, ISCIS = 11 A, R_{GE} = 1 k Ω , VCC = 100 V during inductor charging and VCC = 0 V during time in clamp.



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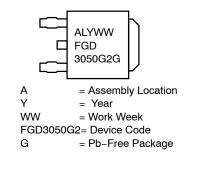
www.onsemi.com





DPAK (SINGLE GAUGE) CASE 369C

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Units
Junction-to-Case - Steady State (Drain)	$R_{ extsf{ heta}JC}$	0.9	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Test Conditions		Min	Тур.	Max.	Units		
OFF CHARA	ACTERISTICS								
BV _{CER}	Collector to Emitter Breakdown Voltage	$\begin{array}{l} I_{CE} = 2 \text{ mA}, V_{GE} = 0 \text{ V}, \\ R_{GE} = 1 k\Omega, T_{J} = -40 \text{ to } 150^{\circ}\text{C} \end{array}$		470	-	530	V		
BV _{CES}	Collector to Emitter Breakdown Voltage	I_{CE} = 10 mA, V_{GE} = 0 V, R _{GE} = 0, T _J = -40 to 150°C		495	-	555	V		
BV _{ECS}	Emitter to Collector Breakdown Voltage	I_{CE} = -75 mA, V_{GE} = 0 V, T_{J} = 25 $^{\circ}C$		20	-	-	V		
BV _{GES}	Gate to Emitter Breakdown Voltage	I _{GES} = ±5 mA		±12	±14	-	V		
I _{CER}	Collector to Emitter Leakage Current	V _{CE} = 250 V	$T_J = 25^{\circ}C$	-	-	25	μA		
				$R_{GE} = 1 \ k\Omega$	$T_J = 150^{\circ}C$	-	-	1	mA
I _{ECS}	Emitter to Collector Leakage Current	V _{EC} = 15 V	$T_J = 25^{\circ}C$	-	-	1	mA		
			$T_J = 150^{\circ}C$	-	-	40	1		
R ₁	Series Gate Resistance			-	111	-	Ω		
R ₂	Gate to Emitter Resistance			10K	-	30K	Ω		
ON CHARAG	CTERISTICS (Note 5)	-			-	-	-		
V _{CE(SAT)}	Collector to Emitter Saturation	$I_{CE} = 6 \text{ A}, \text{ V}_{GE} =$	= 4 V, T _J = 25°C	-	1.1	1.2	V		

	· CE(SAT)	Voltage					
ſ	V _{CE(SAT)}	Collector to Emitter Saturation Voltage	I_{CE} = 10 A, V_{GE} = 4.5 V, T_{J} = 150°C	-	1.3	1.45	V
	V _{CE(SAT)}	Collector to Emitter Saturation Voltage	I_{CE} = 15 A, V_{GE} = 4.5 V, T_{J} = 150°C	-	1.6	1.75	V

DYNAMIC CHARACTERISTICS

Q _{G(ON)}	Gate Charge	I_{CE} = 10 A, V_{CE} = 12 V, V_{GE} = 5 V		-	22	-	nC
V _{GE(TH)}	Gate to Emitter Threshold Voltage	$I_{CE} = 1 \text{ mA}$	$T_J = 25^{\circ}C$	1.3	1.6	2.2	V
		V _{CE} = V _{GE}	$T_J = 150^{\circ}C$	0.75	1.1	1.8	
V _{GEP}	Gate to Emitter Plateau Voltage	$V_{CE} = 12 \text{ V}, I_{CE} = 10 \text{ A}$		-	2.7	-	V

SWITCHING CHARACTERISTICS

td _{(ON)R}	Current Turn-On Delay Time-Resistive		-	0.9	4	μs
t _{rR}	Current Rise Time-Resistive		-	1.6	7	
td _{(OFF)L}	Current Turn-Off Delay Time-Inductive	V_{CE} = 300 V, L = 2 mH, V_{GE} = 5 V, R_{G} = 1 K\Omega,	-	5.4	15	
t _{fL}	Current Fall Time-Inductive		_	1.4	15	

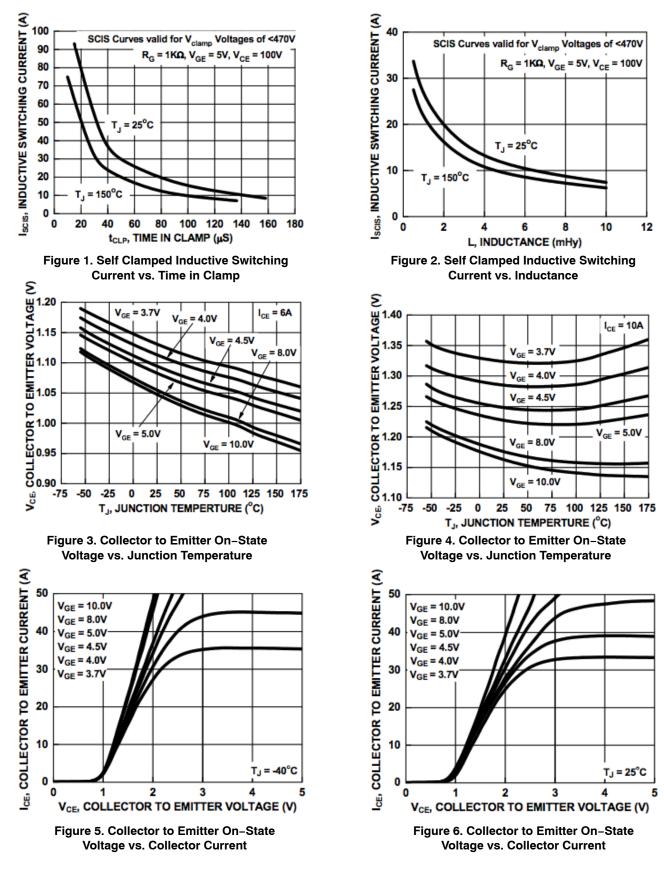
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Package	Reel Diameter	Tape Width	Qty†
FGD3050G2	FGD3050G2V	DPAK (Pb-Free)	330 mm	16 mm	2500

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





TYPICAL CHARACTERISTICS (continued)

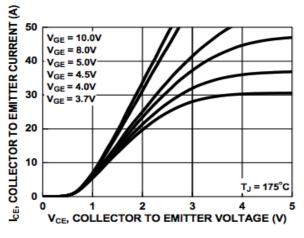
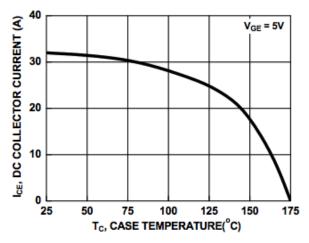
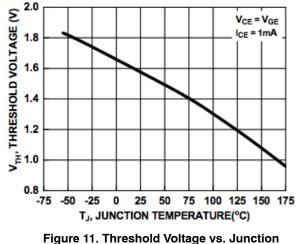


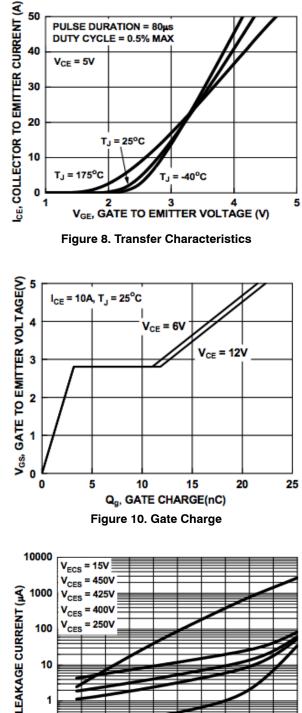
Figure 7. Collector to Emitter On-State Voltage vs. **Collector Current**

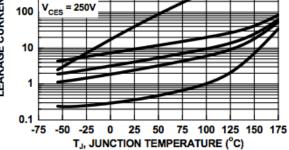




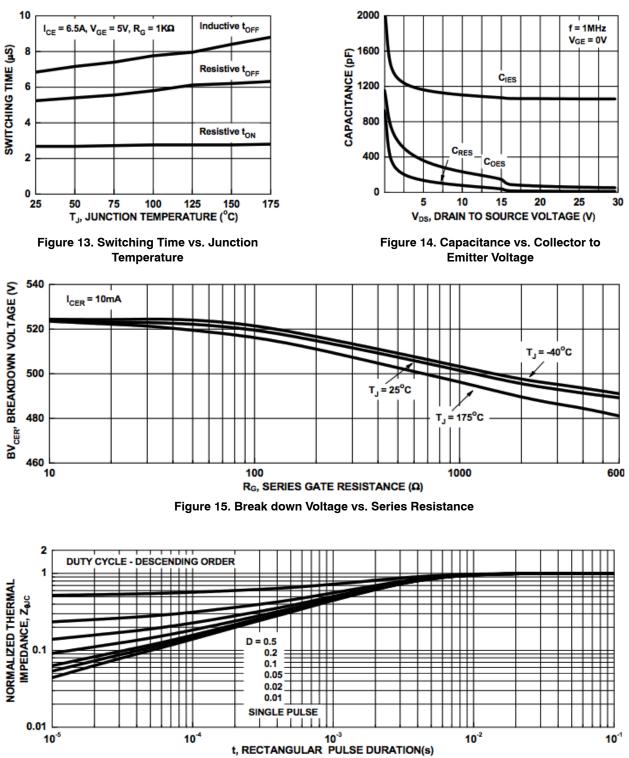


Temperature









TYPICAL CHARACTERISTICS (continued)



SPICE Thermal Model

 CTHERM1
 th 6
 5.7337E-05

 CTHERM2
 6
 5
 5.3736E-03

 CTHERM3
 5
 4
 1.1141E-03

 CTHERM4
 4
 3
 2.8690E-04

 CTHERM5
 3
 2
 7.4429E-04

 CTHERM6
 2
 tl
 3.7019E-03

 RTHERM1
 th 6
 6.6403E-03

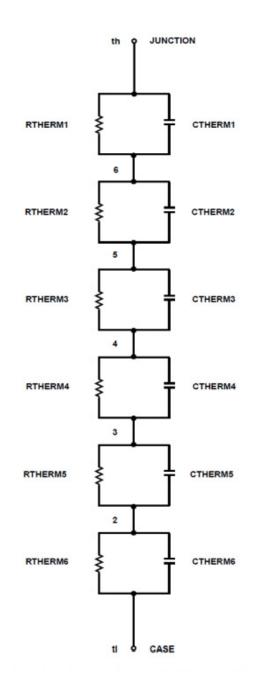
 RTHERM2
 6
 5
 5.8449E-01

 RTHERM3
 5
 4
 5.3930E-02

 RTHERM4
 4
 3
 9.2492E-03

 RTHERM5
 3
 2
 1.5794E-02

 RTHERM6
 2
 tl
 1.7974E-01



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